

PRODUCT NO.
73725

PRODUCT NUMBER CODE

73725-X X X X LF

HOUSING COLOR OPTION
0-WHITE
1-BLACK

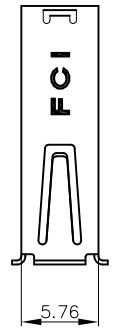
SENSOR CONTACT OPTION
0-WITH SENSOR CONTACT
1-WITHOUT SENSOR CONTACT

SHIELD PLATING OPTION
1- 1.25μm MINIMUM NICKEL UNDERPLATE &
2.5μm MINIMUM BRIGHT TIN OVER ALL AREA.
(HOLD DOWN STYLE "A")
2- 1.25μm MINIMUM NICKEL UNDERPLATED OVER ALL;
2.5 μm MINIMUM MATTE TIN PLATED ON
HOLD DOWN AREA ONLY.(HOLD DOWN STYLE "B")
3- 1.25μm MINIMUM NICKEL UNDERPLATED OVER ALL;
2.5 μm MINIMUM MATTE TIN PLATED ON
HOLD DOWN AREA ONLY.(HOLD DOWN STYLE "A")
4- 1.25μm MINIMUM NICKEL UNDERPLATED &
2.5μm MINIMUM BRIGHT TIN OVER ALL AREA.
(HOLD DOWN STYLE "B")
5- 1.25μm MINIMUM NICKEL UNDERPLATED OVER ALL;
2.5μm MINIMUM MATTE TIN PLATED ON
HOLD DOWN AREA ONLY (HOLD DOWN STYLE "C")
6- 1.25μm MINIMUM NICKEL ONLY.
(HOLD DOWN STYLE "A")
7- 1.25μm MINIMUM NICKEL UNDERPLATED &
2.5 μm MINIMUM MATTE TIN PLATED OVER ALL.
(HOLD DOWN STYLE "A")
8- 1.25μm MINIMUM NICKEL UNDERPLATED &
2.5 μm MINIMUM MATTE TIN PLATED ALL AREA.
(HOLD DOWN STYLE "B")
9- 1.25μm MINIMUM NICKEL UNDERPLATED OVER ALL;
2.5 μm MINIMUM MATTE TIN PLATED ON
HOLD DOWN AREA ONLY (HOLD DOWN STYLE "D")
S- 1.25μm MINIMUM NICKEL ONLY.(HOLD DOWN STYLE "A").
HIGH PERFORMANCE MATERIAL
FOR 12,000 DURABILITY CYCLES
A- 1.25μm MINIMUM NICKEL PLATED OVER ALL
2.5 μm MINIMUM MATTE TIN PLATED ON HOLD DOWN AREA ONLY
(HOLD DOWN STYLE "F")
B- 1.25μm MINIMUM NICKEL PLATED OVER ALL
2.5 μm MINIMUM MATTE TIN PLATED ON HOLD DOWN AREA ONLY
(HOLD DOWN STYLE "F")

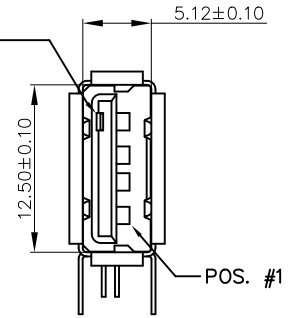
TERMINAL OPTION
50u" NI UNDERPLATE; 30u" GXT CONTACT AREA,100u" TIN TAIL AREA;
0- DIM "A": 2.29 (TERMINAL TAIL LENGTH);
1- DIM "A": 3.71 (TERMINAL TAIL LENGTH);

LEAD FREE OPTION
SEE NOTE 9

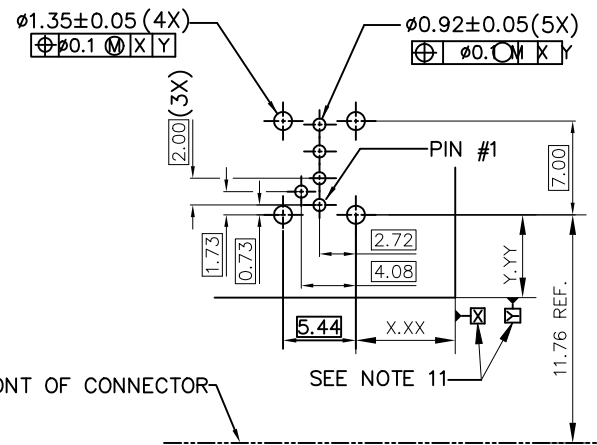
PACKAGING OPTION
B - TUBE
R - TAPE&REEL



SENSOR CONTACT

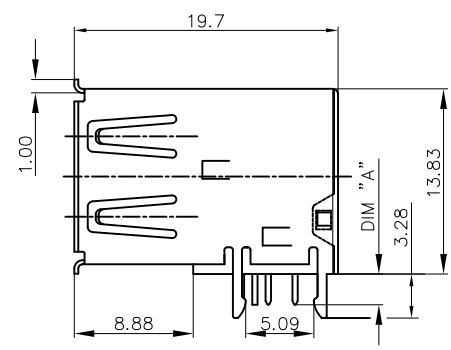


WITH SENSOR CONTACT



FRONT OF CONNECTOR

PC BOARD MOUNTING DIMENSIONS FOR 5 PIN



NOTES:

- MATERIAL:
CONTACTS: COPPER ALLOY
SHIELD: COPPER ALLOY
HOUSING: UL 94V-0 THERMOPLASTIC, COLOR: SEE PRODUCT CODE
- PLATING:
CONTACTS: GOLD FLASH OVER PALLADIUM NICKEL (0.76μm MINIMUM)
IN CONTACT AREA; 2.5 μm TIN MINIMUM IN SOLDER TAIL AREA.
1.27 μm MINIMUM NICKEL UNDERPLATE OVER ALL SURFACES.
SHIELD: SEE PRODUCT NUMBER CODE.
(THE PLATING MEASURE POINT ON THE SHIELD HOLD DOWN AREA ONLY).
- DATUMS & BASIC DIMENSIONS TO BE DETERMINED BY CUSTOMER
- RECOMMENDED PCB BOARD THICKNESS IS 1.00 ~ 1.60mm EXCEPT 73725-1191BLF; 73725-1191BLF CAN BE USED FOR THE PCB BOARD THICKNESS 2.30 ~ 2.65mm.
- MAXIMUM PANEL THICKNESS TO BE 2.67mm IF MOUNTED BEHIND PANEL
- METAL SHELL SLIVER 0.20 MAX.
- NI PLATING DOES NOT COMPLY WITH THE USB STANDARDS (TO BE CONTINUED)

mat'l. code				surface123/tolerance			projection	product family		
ltr	ecn no	dr	date	ISO 1302	ISO 406	ISO 1101		HPL 511 USB 2.0		
AJ	ELX-N-27708	LZ	2017/08/15	tolerances unless otherwise specified				title		
				angles	linear					
AD	ELX-N-012006	A.ZH	06/25/2012	0±2°			scale 1:1	USB UP-RIGHT RECEPT		
AE	ELX-N-13463	A.ZH	11/14/2012	dr	PAMP	5/20/97	Amphenol FCI	dwg no sheet 1 of 4 size		
AF	ELX-N-14592	J.HAN	06/10/2013	eng	R Y LIU	5/20/97				
AG	ELX-N-21594	LQ	08/04/2015	chr	R Y LIU	5/20/97				
AH	ELX-N-21919	LQ	08/04/2015	app	JENN TSAO	5/20/97				
sheet	revision							type Product Customer Drawing		
index	sheet									

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(CONTINUED)

8. P/N'S WITH SUFFIX "LF" ARE LEAD FREE P/N'S

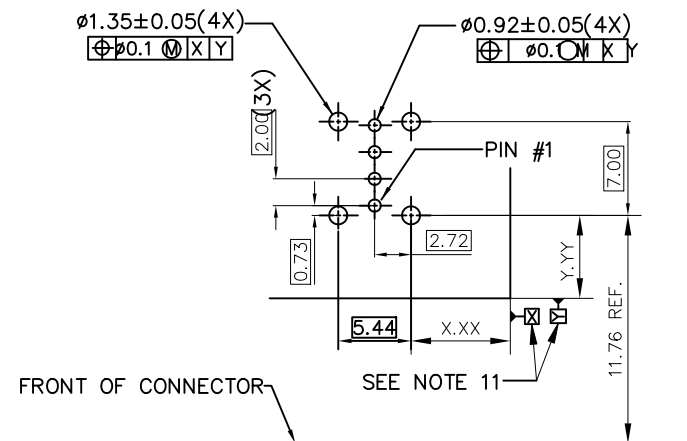
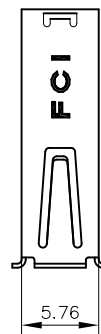
FOR LEAD FREE P/N, THE PRODUCT MEET EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008

FOR THE PRODUCTS WITH THE METAL SHELL PLATING NICKEL AND MATTE SN CAN WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 40 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW PROCESS; FOR THE PRODUCTS WITH METAL SHELL PLATING BRIGHT SN OR SEMI-BRIGHT SN CAN'T WITHSTAND REFLOW AND JUST CAN WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN WAVE SOLDERING PROCESS.

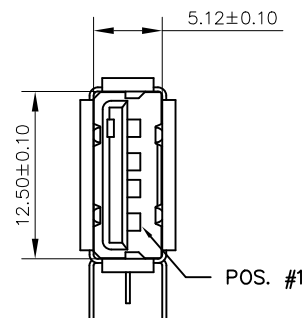
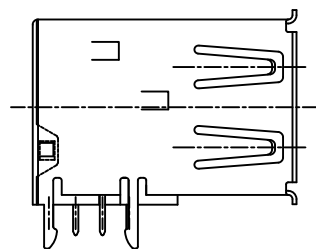
FOR ALL LEAD FREE P/N'S, WITH SUFFIX LF.

12. THE PRODUCT CAN BE USED FOR PIP PROCESS

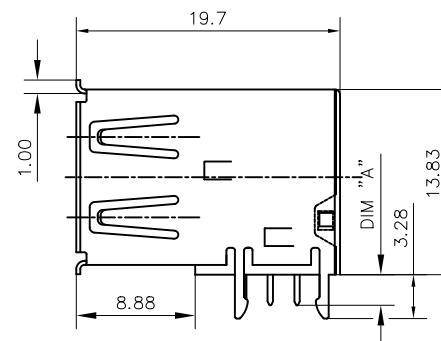
13. DATUM OF CUSTOMER'S PCB LAYOUT.



PC BOARD MOUNTING DIMENSIONS FOR 4 PIN



WITHOUT SENSOR CONTACT

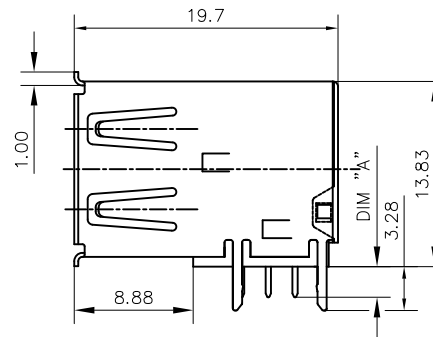
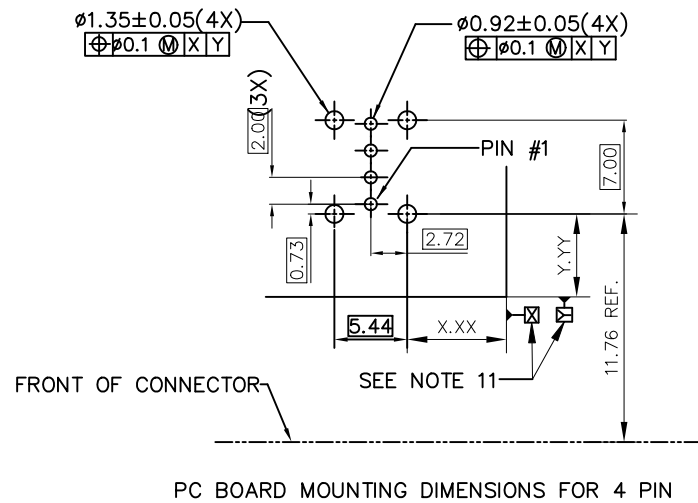


FOR 73725-X1X0B
HOLD DOWN STYLE "A"

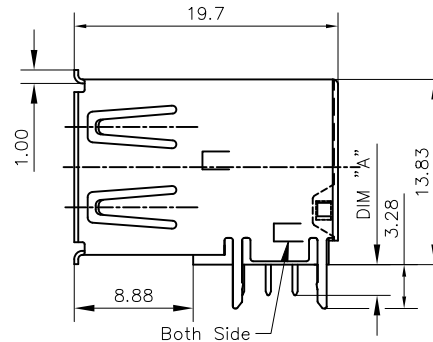
mat'l. code				surface ¹²³ /tolerance			projection 	product family		
				ISO 1302 ✓ ISO 406 ISO 1101				HPL 511 USB 2.0		
ltr	ecn	no	dr	date	tolerances unless otherwise specified			title		
AJ					angles			USB UP-RIGHT		
					linear	.0±.30		mm 	RECEPT	
						.00±.20				
					0°±2'	.000±.10		scale 1:1		
					dr	PAMP	5/20/97	Amphenol FCI	dwg no	
					eng	R Y LIU	5/20/97		sheet2 of 4	
					chr	R Y LIU	5/20/97		73725	
					app	JENN TSAO	5/20/97		A3	
sheet index	revision		sheet						type Product Customer Drawing	
								</		

PRODUCT NO.

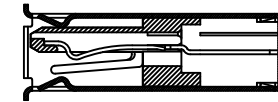
73725



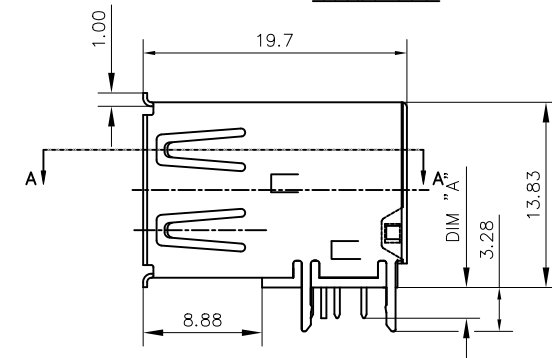
WITHOUT SENSOR CONTACT
FOR 73725-X1X0B
HOLD DOWN STYLE "B"



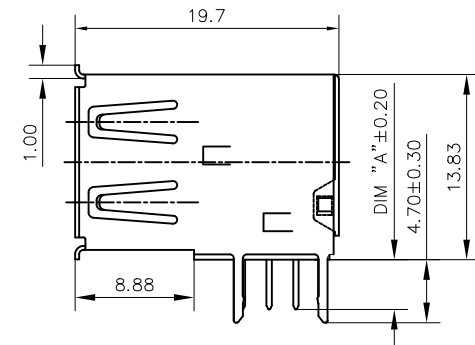
WITHOUT SENSOR CONTACT
FOR 73725-XXA0XLF
73725-XXB0XLF ONLY
HOLD DOWN STYLE "F"



SECTION A-A



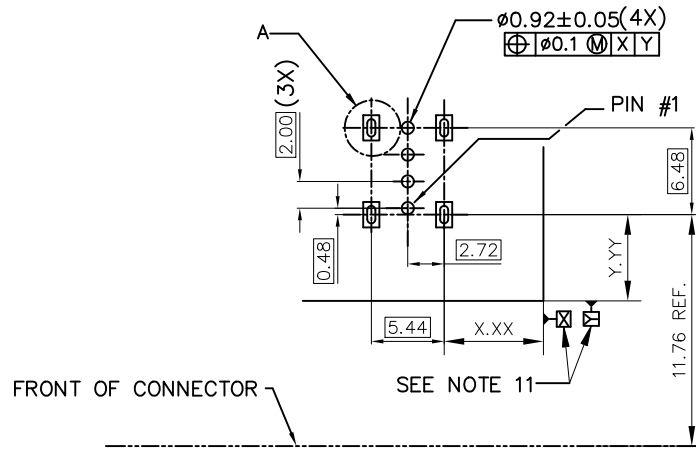
WITH SENSOR CONTACT
FOR 73725-X0X0B
HOLD DOWN STYLE "B"



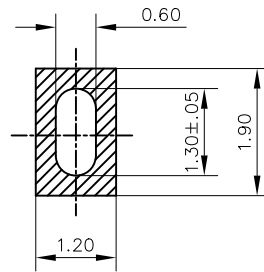
WITHOUT SENSOR CONTACT
FOR 73725-X191XLF
HOLD DOWN STYLE "D"

mat'l. code				surface ¹²³ ISO 1302 ✓		toleranceISO 406 ISO 1101		projection 		product familyHPL 511 USB 2.0			
ltr	ecn	no	dr	date		tolerances unless otherwise specified				title			
AJ						angleslinear		.0±.30 .00±.20 .000±.10		USB UP-RIGHT RECEPT			
						0°±2'		mm — mm —		scale 1:1			
						drPAMP		5/20/97		dwg no			
						engR Y LIU		5/20/97		sheet3 of 4			
						chrR Y LIU		5/20/97		sizeA3			
						appdJENN TSAO		5/20/97		typeProduct Customer Drawing			
sheet index		revision sheet											

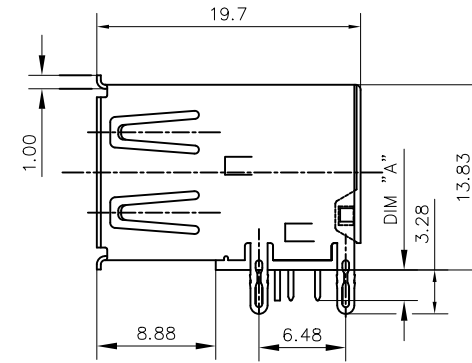
PRODUCT NO.
73725



PC BOARD MOUNTING DIMENSIONS FOR 4 PIN



DETAIL A 5 : 1



WITHOUT SENSOR CONTACT
FOR 73725-X150B
HOLD DOWN STYLE "C"

mat'l. code				surface ¹²³	tolerance	projection	product family			
				ISO 1302	ISO 406	ISO 1101	HPL 511 USB 2.0			
ltr	ecn no	dr	date	tolerances unless otherwise specified			title			
AJ				angles	linear	mm	USB UP-RIGHT RECEPT			
				0°±2°		scale 1:1				
				dr	PAMP	5/20/97	dwg no			
				engr	R Y LIU	5/20/97	sheet 4 of 4			
				chr	R Y LIU	5/20/97	73725			
				appd	JENN TSAO	5/20/97	type Product Customer Drawing			
sheet index	revision sheet									



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

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